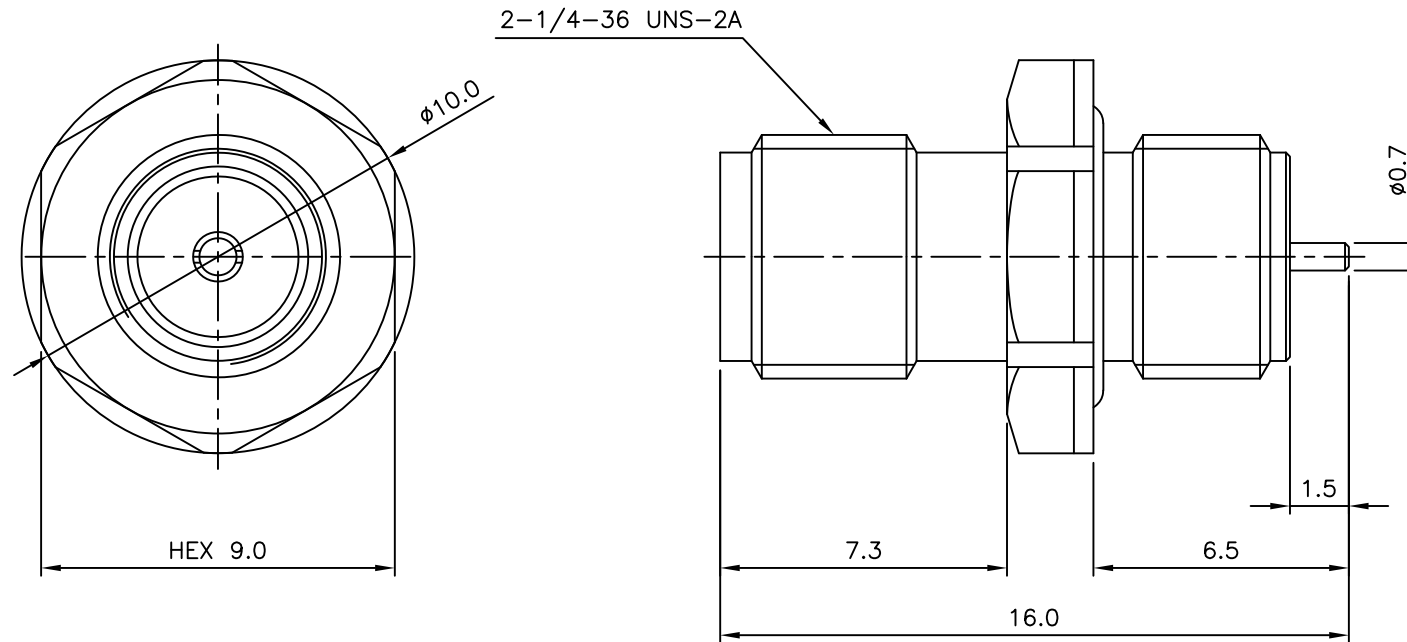
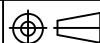


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1	Initial Registration	S.Y.EUN	I.C.KIM	2019.09.23.



4	INSULATOR	1	TEFLON		DIN02077-N/1
3	GASKET	1	NBR		DGK00019-N/1
2	CONTACT	1	BeCu C17300	Gold Plate (0.4 μ m)	DCT03299-5/3
1	BODY	1	MBsBD C3604BD-F	Nickel Plate (5 μ m)	DBD03779-5/4
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.3	DATE 2019. 09. 23.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle ±1°	APPROVED BY I.C.KIM			
MATERIAL _____		CHECKED BY	TITLE SMA50 SOLDER END JB (F/F)		
		DRAWN BY S.Y.EUN			
FINISH _____	SCALE 5/1	UNIT mm		A4	DWG NO. CN03341-7/3
				REVISION I R	SHEET 1 of 1